

## 3.2 SPECIFIC DEVICES

Let us now focus on several selected silicon photonic devices and understand their operation principles with more details.

### 3.2.1 Modulator Based on Carrier Depletion in Silicon

In Ref. [16] the authors presented the realization of a high-speed silicon modulator based on carrier depletion in silicon waveguide. The basic phenomenon is related to the plasma dispersion effect mentioned in the previous chapter of this book. The free carriers' generation is related to depletion region of pn junctions. The device described in Ref. [16] is based on an MZI with a reverse-biased pn diode embedded in each of the two arms of the interferometer. The MMI coupler is used because it has a broader range of operating wavelengths and larger fabrication tolerance as compared to a directional coupler.

The fabrication process was designed to target the pn junction at approximately  $0.4\mu\text{m}$  above the buried oxide to enable optimal modal overlap with the depletion region. As the n-doping concentration is much higher than the p-doping concentration, carrier depletion under reverse bias occurs mainly in the p-type doped region which results by improved phase modulation efficiency due to the hole density change providing larger refractive index change as compared to the electron density change.

Note that pn junction-based silicon modulator has a fast intrinsic response (the transverse response time is  $\sim 7\text{ps}$ ). However, in order to obtain the high-frequency operation it is essential to overcome the issues associated with the relatively large pn junction capacitance and metal contact parasitics. To minimize the  $RC$  limitation of the frequency response of the modulator the authors of Ref. [16] realized traveling wave electrode based on coplanar waveguide structure. The RF traveling wave coplanar waveguide and modulator optical waveguide are carefully designed so that both electrical and optical signals co-propagate along the length of the phase shifter with similar speeds, while, at the same time, the RF attenuation is kept as small as possible.

For a reverse-biased pn junction, the depletion width depends on the bias voltage and doping concentrations. For the asymmetrically doped pn junction as done in Ref. [16] the depletion width ( $W_D$ ) can be approximated following the formulations presented in the theoretical background chapter on semiconductors:

$$W_D = \sqrt{\frac{2\varepsilon_0\varepsilon_r(V_{bi} + V_{in})}{qN_A}} \quad (3.2)$$

where  $\varepsilon_0$  and  $\varepsilon_r$  are the vacuum permittivity and the low-frequency relative permittivity of silicon,  $q$  is the electron charge,  $N_A$  is the acceptor concentration,  $V_{bi}$  is the built-in voltage and  $V_{in}$  is the applied voltage. Changing the depletion width of a pn junction is equivalent to changing the free carrier density. Thus, by changing the bias voltage, one can achieve refractive index modulation through the free carrier plasma dispersion effect.

Photonic modulators based upon the depletion region have small signal transient response which determines the feasibility of the device to be used for high-speed data modulation. The small signal response will be defined by the depletion or junction capacitance  $C_J$  [15]. Following the technical



The refractive index of the material between two mirrors is denoted by  $n$  and the refractive index of the materials outside the mirrors by  $n'$ . We assume that an incident ray with an amplitude of  $A_i$  is arriving at the first mirror surface at an angle of  $\theta'$ . The amplitudes of the back-reflected beams are  $B_1, B_2$  etc., while the subscript indicates the order of reflection. The amplitudes of the transmitted beams are denoted by  $A_1, A_2$  etc., while again the subscript indicates the order of transmission. We assume that the transmission coefficient for the electrical field when going from material  $n'$  towards material  $n$  is denoted by  $t$  and the transmission coefficient for light going in the opposite direction is  $t'$ . The reflective coefficients for the field are denoted as  $\Gamma$  and  $\Gamma'$  for beam that is back-reflected from material with refraction index of  $n$  or  $n'$  respectively.

Let us start by computing the length of the paths CB and BA which are responsible for the phase optical path difference generated between any two adjacent transmitted beams. The sum of the paths equals:

$$CB + BA = 2L \cos \theta \quad (3.3)$$

Thus the optical path difference will be:

$$\delta = \frac{2\pi n}{\lambda_V} (CB + BA) = \frac{4\pi n L}{\lambda_V} \cos \theta = \frac{4\pi n \nu}{c} \cos \theta \quad (3.4)$$

where  $\lambda_V$  is the wavelength in vacuum and  $c$  is the speed of light in vacuum. The coefficients of the reflected field are:

$$\begin{aligned} B_1 &= \Gamma A_i \\ B_2 &= t t' \Gamma' A_i \exp(i\delta) \\ B_3 &= t t' \Gamma' A_i \exp(i\delta) (\Gamma'^2 \exp(i\delta)) \\ &\vdots \\ B_n &= B_{n-1} (\Gamma'^2 \exp(i\delta)) \end{aligned} \quad (3.5)$$

Using the geometrical series expression yields:

$$B_{tot} = \sum_n B_n = A_i \left( \Gamma + t t' \Gamma' \frac{\exp(i\delta)}{1 - \Gamma'^2 \exp(i\delta)} \right) \quad (3.6)$$

The expressions for the amplitudes of the transmitted field yield:

$$\begin{aligned} A_1 &= A_i t t' \exp(i\delta') \\ A_2 &= A_i t t' \exp(i\delta') (\Gamma'^2 \exp(i\delta)) \\ A_3 &= A_i t t' \exp(i\delta') (\Gamma'^2 \exp(i\delta))^2 \\ &\vdots \\ A_n &= A_{n-1} (\Gamma'^2 \exp(i\delta)) \end{aligned} \quad (3.7)$$

and the final results of the summation equal:

$$A_{tot} = \sum_n A_n = A_i t t' \Gamma' \frac{\exp(i\delta')}{1 - \Gamma'^2 \exp(i\delta)} \quad (3.8)$$

where

$$\delta' = \frac{2\pi n}{\lambda_v} \frac{L}{\cos \theta} \quad (3.9)$$

Following the Stokes principle we have:

$$\begin{aligned} \Gamma' &= -\Gamma \\ t t' &= 1 - \Gamma^2 \end{aligned} \quad (3.10)$$

Thus, one may obtain that the reflection or transmitted ratios equal:

$$\begin{aligned} \frac{A_{tot}}{A_i} &= (1 - \Gamma^2) \frac{\exp(i\delta')}{1 - \Gamma^2 \exp(i\delta)} \\ \frac{B_{tot}}{A_i} &= \Gamma \frac{1 - \exp(i\delta)}{1 - \Gamma^2 \exp(i\delta)} \end{aligned} \quad (3.11)$$

Those relations are for the electric field. For intensities one obtains:

$$\begin{aligned} \frac{I_t}{I_i} &= \frac{|A_{tot}|^2}{|A_i|^2} = \frac{(1 - R)^2}{(1 - R)^2 + 4R \sin^2(\delta/2)} \\ \frac{I_r}{I_i} &= \frac{|B_{tot}|^2}{|A_i|^2} = \frac{4R \sin^2(\delta/2)}{(1 - R)^2 + 4R \sin^2(\delta/2)} \end{aligned} \quad (3.12)$$

where  $R$  is the reflection coefficient for the intensity:

$$R = |\Gamma|^2 \quad (3.13)$$

One may clearly see the conservation of energy, since:

$$\frac{I_r}{I_i} + \frac{I_t}{I_i} = 1 \quad (3.14)$$

Optical frequencies of maximal transmission are obtained when the expression for  $I_t/I_i$  is maximized, i.e. for:

$$\nu_m = m \frac{c}{2nL \cos \theta} \quad (3.15)$$

where  $m$  is an integer number. The distance between two transmission peaks, also called the free spectral range (FSR), is equal to:

$$\Delta\nu = \nu_{m+1} - \nu_m = \frac{c}{2nL\cos\theta} \quad (3.16)$$

and in order to convert this equation to wavelength units, we use the well-known relation of:

$$\lambda_m \nu_m = c, \quad (3.17)$$

to obtain:

$$\Delta\lambda = \frac{c}{\nu^2} \Delta\nu = \frac{\lambda^2}{c} \Delta\nu \quad (3.18)$$

yielding:

$$\Delta\lambda = \frac{\lambda^2}{2nL\cos\theta} \quad (3.19)$$

From Eq. 3.16 one may extract the frequencies of the peaks:

$$\nu_m = m\Delta\nu \quad (3.20)$$

Defining the criteria of half width half maximum (HWHM) as the width of each transmission peak:

$$I_t = \frac{I_i}{2} \quad (3.21)$$

yields the following:

$$4R\sin^2(\delta_{1/2}/2) = (1 - R)^2 \quad (3.22)$$

which results in:

$$\text{HWHM} = \delta_{1/2} - 2m\pi = \frac{1 - R}{\sqrt{R}} \quad (3.23)$$

Thus, the width of the peak is equal to:

$$\Delta\nu_{1/2} = \frac{c}{4\pi nL\cos\theta} \cdot \delta = \frac{c}{4\pi nL\cos\theta} \cdot 2(\delta_{1/2} - 2m\pi) \quad (3.24)$$

or:

$$\Delta\nu_{1/2} = \frac{c}{2\pi nL\cos\theta} \cdot \frac{1 - R}{\sqrt{R}} = \frac{\Delta\nu}{\pi} \cdot \frac{1 - R}{\sqrt{R}} \quad (3.25)$$

Following that, the finesse of the resonator is defined as:

$$\mathfrak{F} = \frac{\Delta\nu}{\Delta\nu_{1/2}} = \pi \frac{\sqrt{R}}{1 - R} \quad (3.26)$$

The main advantage of using a ring resonator is the good match it proposes for integrated circuits and waveguides. The theory of ring resonators is similar to the previously developed insights on Fabry–Perot. However, some parameters are expressed differently. Ring resonators sometimes have four terminals coupled together through two couplers. The coupling efficiency is determined according to the proximity between the waveguides and the ring structure in the center of the resonator (schematic sketch is seen in Fig. 3.11).

If a wavelength  $\lambda_m$  satisfies the resonant condition of

$$n_{eff}\pi D = m\lambda_m \quad (3.27)$$

and is input through terminal 1, the coupling of the wave with that wavelength will be enhanced and all others will be suppressed. As a result, only this wavelength will be dropped from terminal 4, while the rest of the wavelengths will pass through and output from terminal 2. In the last equation  $n_{eff}$  is the effective refractive index of the bending waveguide,  $D$  is the diameter of the ring and  $m$  is an integer. If observing again Eq. 3.15 and using the relation connecting the optical wavelength and the optical frequency (Eq. 3.17) one obtains that for Fabry–Perot the resonance condition is:

$$n_{eff}2L\cos\theta = m\lambda_m \quad (3.28)$$

and thus by choosing  $\pi D \sim 2L\cos\theta$  both equations will coincide, simply because  $\pi D$  represents the circumference of the ring. The FSR is one of the key specifications of the ring resonator. It is defined as:

$$\text{FSR} = \frac{\lambda_m^2}{n_{eff}(\pi D + L_c)} \quad (3.29)$$

where  $L_c$  is the length of the coupler. If comparing this with Eq. 3.19 one may see that for  $\pi D + L_c \sim 2L\cos\theta$  both equations coincide.

Because the FSR is inversely proportional to the size of the ring resonator, the ring must be small in order to achieve a high FSR. The finesse of the ring resonator is defined in the same way as in Fabry–Perot (Eq. 3.26) but the “reflectivity”  $R$  is defined as:

$$R = \exp(-\alpha)(1 - \kappa) \quad (3.30)$$

where  $\alpha$  is the total amplitude attenuation coefficient for each round trip, and  $\kappa$  is the normalized coupling coefficient of the coupler.

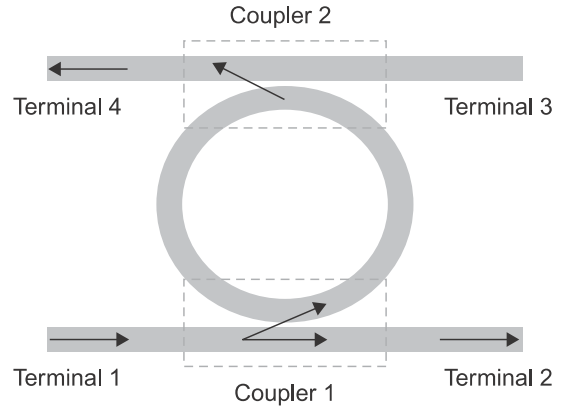
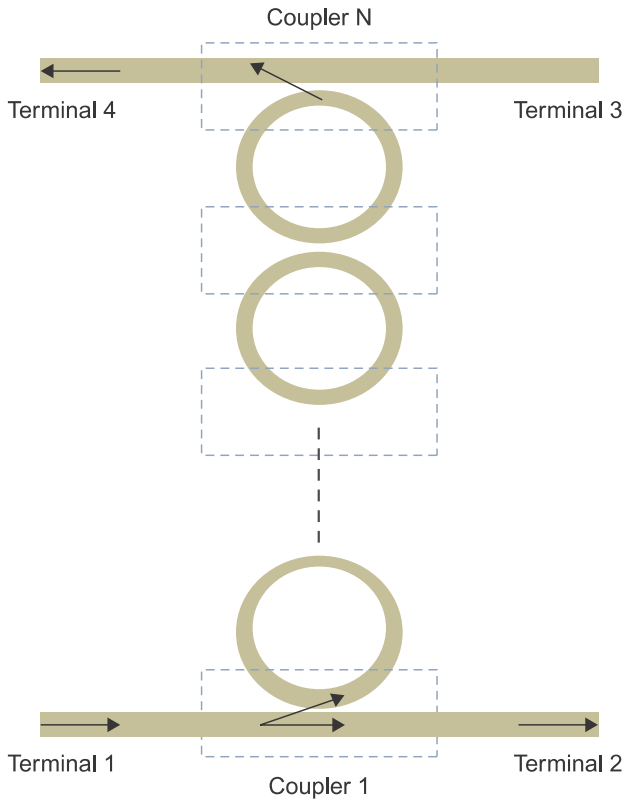


FIGURE 3.11

Schematic sketch of ring resonator.

**FIGURE 3.12**

Schematic sketch of multiple ring resonators.

It is almost always advantageous to reduce both the internal and external losses in order to obtain higher finesse. However, the external loss due to coupling is necessary and cannot be too small for the resonator to operate as an optical filter. If the external loss is smaller than the internal loss, all the coupled power will be lost inside the cavity and no power will be coupled out. Because of these constraints, the ring resonator must use a strongly guided waveguide to minimize the bending loss for a curved waveguide with a very small radius.

One option to increase the finesse is to use multiple ring resonators where two or more rings could be coupled in cascade as shown in Figure 3.12. In this case, the FSR is increased and the combined FWHM is accordingly reduced. The various resonators have to be carefully designed to make sure that the spectral position of the desired resonance wavelength will coincide in all of the cascaded resonators.

An important parameter is the quality factor  $Q$  which is directly proportional to the finesse as follows:

$$Q = \frac{n_{\text{eff}} \pi D}{\lambda_m} \Im \quad (3.31)$$

### 3.2.2.2 Resonator Based on Low Refractive Index Holes

The device described in Ref. [27] includes a Fabry–Perot resonator that is realized by creating low-refractive-index holes in silicon waveguide in order to realize reflective mirrors. It is well known that the Fresnel reflection coefficients, generated when an optical beam passes between two mediums with different refraction index, are equal to:

$$R = \left( \frac{n_1 - n_2}{n_1 + n_2} \right)^2 \quad (3.32)$$

where  $n_1$  and  $n_2$  are the refraction indices of the two mediums. In the case described in Ref. [27] and in Figure 3.9, air holes are generated in the silicon waveguide. Since the refraction index of silicon is about  $n_1 = 3.5$  and if air holes are created then  $n_2 = 1$  and we have  $R = 0.3$ . If the periodic structure

of such holes is realized a Bragg mirror can be generated for wavelength corresponding to twice the distance between adjacent holes (denoted by  $\Lambda$ ) multiplied by the effective refraction index  $n_{eff}$ :

$$\lambda_m = 2\Lambda n_{eff} \quad (3.33)$$

If this wavelength corresponds with the resonance condition of Fabry–Perot (see Eq. 3.28) then a matched resonator is realized. The refraction index of the cavity is modified due to the plasma dispersion effect leading to realization of a modulation depth ( $MD$ ) of:

$$MD \propto \frac{\delta\lambda_{Resonance\ Shift}}{\Delta\lambda_{FWHM}} \quad (3.34)$$

where  $\delta\lambda_{Resonance\ Shift}$  is the absolute shift of the resonance peak,  $\Delta\lambda_{FWHM}$  is the full-width half maximum of the resonance, which is a measure of the bandwidth of the device, and  $Q$  is the quality factor (see Eqs. 3.25 and 3.31). The shift of the resonance  $\delta\lambda_{Resonance\ Shift}$  is directly proportional to the change in the refraction index (see Eqs. 3.15 and 3.17).

The change in the refraction index is proportional to  $P$ , being the power required to maintain a certain number of steady-state absolute carriers in a given geometry, divided by the length  $L$  of the device at a certain carrier concentration for a given cross-sectional area  $A$ . This is because the concentration of the generated free carriers is proportional to the absorbed power per relevant unit of volume. This concentration eventually changes the refraction index of the resonator following the well-known plasma dispersion effect that was previously explained. Therefore one may write:

$$MD \propto \frac{Q \cdot P}{A \cdot L}$$

A figure of merit (FOM) for these modulators is the total amount of bandwidth desired at a certain modulation depth, and the power required to do so. Using Eq. 3.34 one obtains that:

$$FOM = \frac{MD \cdot Bandwidth}{P} \propto \frac{1}{V_{eff}} \quad (3.35)$$

where  $V_{eff} = AL$  is the effective volume of the refractive index-changing cavity region.

In the configuration as proposed by Ref. [27] where the authors use linear Fabry–Perot cavity with a cavity length of only  $2.51\ \mu\text{m}$  one may obtain  $V_{eff}$  as small as  $3.4(\lambda/n_{eff})^3$ . This is a very small number defining a large FOM. A ring resonator with diameter of  $10\ \mu\text{m}$  has  $V_{eff}$  that is more than 12 times larger.

### 3.2.2.3 Carrier-Injected Micro Ring Resonator-Based Modulator

In Ref. [20] a micro ring resonator is used where the modulation is obtained using carrier injection which modifies the refraction index of the resonator due to the plasma dispersion effect. The operation speed of the p-i-n modulator is conventionally thought to be limited by the relatively slow carrier dynamics in the junction. However, the optical response time, in contrast to the electrical response time, can be much shorter thanks to the non-linear transfer function of the device, enabling much



faster modulation. The non-linear relationship between the optical transmission  $T$  at wavelength of  $\lambda_0$  and the total charge  $q_{tot}$  in the junction is given by [20]:

$$T = \frac{\left( \frac{2q_{tot}\Gamma_0\gamma Q}{qn_g V_{eff}} \right)^2}{1 + \left( \frac{2q_{tot}\Gamma_0\gamma Q}{qn_g V_{eff}} \right)^2} \quad (3.36)$$

where  $q$  is the charge of an electron,  $n_g = 4.3$  is the group index of the ring,  $V_{eff} = 4.5 \times 10^{-12}[\text{cm}^3]$  is the volume of the junction,  $\Gamma_0 = 0.8$  is the mode confinement factor,  $\gamma \approx 4.3 \times 10^{-21}[\text{cm}^3]$  is the ratio between the change of refractive index of silicon and the electron-hole-pair density  $\Delta N$  when  $\Delta N \approx 10^{17}[\text{cm}^{-3}]$  and  $Q \approx 20\,000$  is the quality factor of the ring resonator.

For simplicity, we assume that the ring resonator is critically coupled to the waveguide, so that the optical transmission is zero at  $\lambda_0$ . When the p-i-n diode is forward biased, the electron and hole densities in the intrinsic region are equal, which means that the total charge carried by electrons and holes satisfies  $-q_e = q_h = q_{tot}$ . Under dynamic driving voltage, the charge  $q_{tot}$  in the junction follows the first-order differential equation involving the serial resistance of the diode and the average carrier recombination lifetime in the device (denoted as  $\tau$ ). The rise time of the optical transmission is much shorter than the rise time of the charge dynamics, which is determined by the carrier dynamics with positive bias voltage.

The rise time of the charge injection, defined as the time needed for  $q_{tot}$  to reach 0.9 of the steady-state charge, is proportional to  $\tau$ . On the other hand one can see that the optical transmission quickly saturates to about 100% as the charge  $q_{tot}$  increases. Specifically, the transmission  $T > 90\%$  as long as we have charge of  $q_{tot} > 3qn_g V_{eff} / 2q_{tot}\Gamma_0\gamma$ . Therefore, the optical rise time is only determined by the time needed to inject this amount of charge into the junction, which can be much shorter than the rise time of charge injection, if this charge is smaller than the steady-state charge.

Note that the photon lifetime of a ring resonator at  $\lambda_0$  resonance can be obtained from the quality factor as:

$$\tau_{cav} = \frac{Q\lambda_0}{2\pi c} \quad (3.37)$$

where  $c$  is the speed of light. This lifetime can be equal to 9.1 ps in case of a ring resonator with  $Q$  factor of about 10 000 (and a diameter of  $10\,\mu\text{m}$  as presented in Ref. [38]) and at wavelength around 1550 nm. This lifetime gives the fundamental limit to the operation speed of the device which once again can be a very high one and to match the constantly increasing requirements in the field of optics communication.

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